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# FAN73611

## Single-Channel High-Side Gate Drive IC

### Features

- Floating Channel for Bootstrap Operation to +600V
- 250 mA/500 mA Sourcing/Sinking Current Driving Capability
- Common-Mode dv/dt Noise-Canceling Circuit
- 3.3 V and 5 V Input Logic Compatible
- Output In Phase with Input Signal
- Under-Voltage Lockout for  $V_{DD}$  and  $V_{BS}$
- 8-Lead Small Outline Package (SOP)

The FAN73611 is a monolithic high-side gate drive IC that can drive MOSFETs and IGBTs operating up to +600 V. Fairchild's high-voltage process and common-mode noise canceling techniques provide stable operation of the high-side driver under high dv/dt noise circumstances. An advanced level-shift circuit offers high-side gate driver operation up to  $V_S=-9.8$  V (typical) for  $V_{BS}=15$  V. The UVLO circuits prevents malfunction when  $V_{DD}$  or  $V_{BS}$  is lower than the specified threshold voltage. The output drivers typically source/sink 250 mA/500 mA; respectively, which is suitable for Plasma Display Panel (PDP) application, motor drive inverter, and switching mode power supply applications.

### Applications

- Electronic Ballast
- Switching-Mode Power Supply (SMPS)

8-SOP



### Related Application Notes

- [AN-6076 — Design and Application Guide of Bootstrap Circuit for High-Voltage Gate-Drive IC](#)
- [AN-9052 — Design Guide for Selection of Bootstrap Components](#)
- [AN-8102 — Recommendations to Avoid Short Pulse Width Issues in HVIC Gate Driver Applications](#)

### Description

### Ordering Information

Part Number	Package	Operating Temperature	Packing Method	Description
FAN73611MX <sup>(1)</sup>	8 SOP	-40°C ~ 125°C	Tape & Reel	Lighting Application

#### Note:

1. This device passed wave soldering test by JESD22A-111.

Typical Application Diagrams

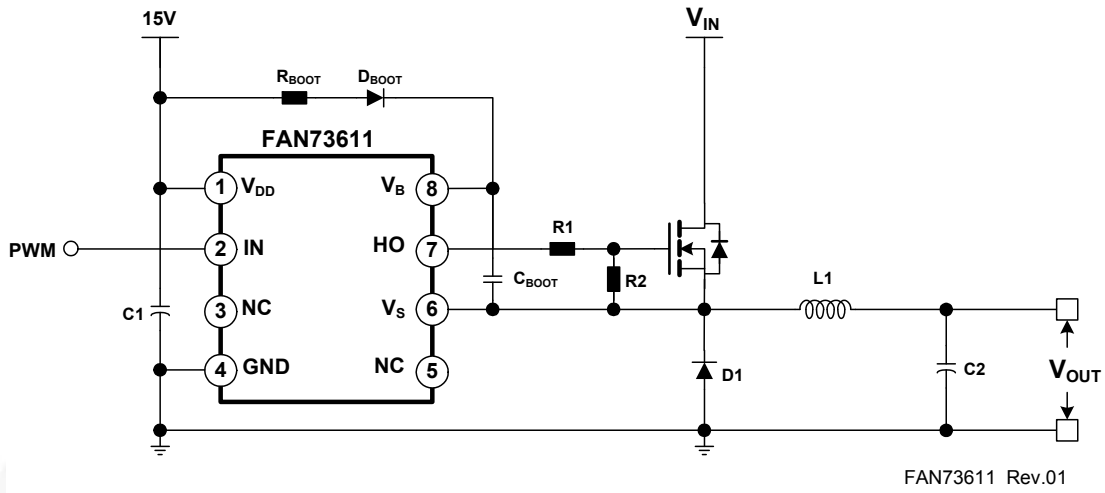


Figure 1. Step-Down (Buck) DC-DC Converter Application

Internal Block Diagram

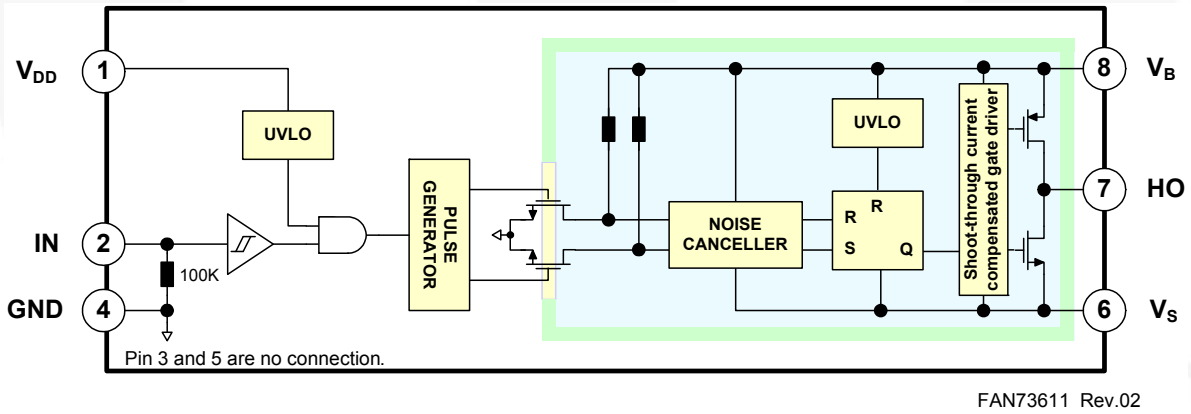


Figure 2. Functional Block Diagram

### Pin Configuration

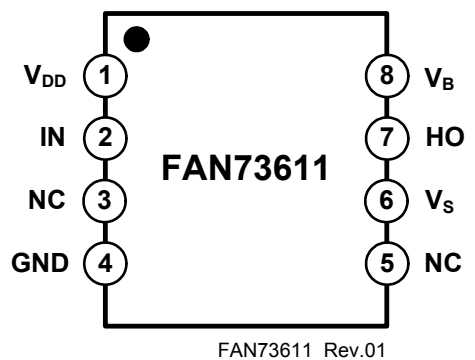


Figure 3. Pin Configuration (Top View)

### Pin Definitions

Pin #	Name	Description
1	V <sub>DD</sub>	Supply Voltage
2	IN	Logic Input for High-Side Gate Driver Output
3	NC	No Connection
4	GND	Ground
5	NC	No Connection
6	V <sub>S</sub>	High-Voltage Floating Supply Return
7	HO	High-Side Driver Output
8	V <sub>B</sub>	High-Side Floating Supply

## Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.  $T_A=25^{\circ}\text{C}$  unless otherwise specified.

Symbol	Characteristics	Min.	Max.	Unit
$V_S$	High-Side Floating Offset Voltage	$V_B-25$	$V_B+0.3$	V
$V_B$	High-Side Floating Supply Voltage	-0.3	625.0	V
$V_{HO}$	High-Side Floating Output Voltage	$V_S-0.3$	$V_B+0.3$	V
$V_{DD}$	Low-Side and Logic Supply Voltage	-0.3	25.0	V
$V_{IN}$	Logic Input Voltage	-0.3	$V_{DD}+0.3$	V
$dV_S/dt$	Allowable Offset Voltage Slew Rate		$\pm 50$	V/ns
$P_D$	Power Dissipation <sup>(2, 3, 4)</sup>		0.625	W
$\theta_{JA}$	Thermal Resistance		200	$^{\circ}\text{C}/\text{W}$
$T_J$	Junction Temperature	-55	+150	$^{\circ}\text{C}$
$T_{STG}$	Storage Temperature	-55	+150	$^{\circ}\text{C}$

### Notes:

- Mounted on 76.2 x 114.3 x 1.6 mm PCB (FR-4 glass epoxy material).
- Refer to the following standards:  
*JESD51-2: Integrated circuits thermal test method environmental conditions, natural convection, and*  
*JESD51-3: Low effective thermal conductivity test board for leaded surface mount packages.*
- Do not exceed power dissipation ( $P_D$ ) under any circumstances.

## Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Min.	Max.	Unit
$V_B$	High-Side Floating Supply Voltage	$V_S+10$	$V_S+20$	V
$V_S$	High-Side Floating Supply Offset Voltage	$6-V_{DD}$	600	V
$V_{HO}$	High-Side Output Voltage	$V_S$	$V_B$	V
$V_{IN}$	Logic Input Voltage	GND	$V_{DD}$	V
$V_{DD}$	Supply Voltage	10	20	V
$T_A$	Operating Ambient Temperature	-40	+125	$^{\circ}\text{C}$

## Electrical Characteristics

$V_{BIAS}(V_{DD}, V_{BS}) = 15.0\text{ V}$  and  $T_A = 25^\circ\text{C}$  unless otherwise specified. The  $V_{IN}$  and  $I_{IN}$  parameters are referenced to GND. The  $V_O$  and  $I_O$  parameters are relative to  $V_S$  and are applicable to the respective output HO.

Symbol	Characteristics	Test Condition	Min.	Typ.	Max.	Unit
<b>Power Supply Section</b>						
$I_{QDD}$	Quiescent $V_{DD}$ Supply Current	$V_{IN}=0\text{ V}$ or $5\text{ V}$ , $C_{LOAD}=1000\text{ pF}$		80	140	$\mu\text{A}$
$I_{PDD}$	Operating $V_{DD}$ Supply Current	$C_{LOAD}=1000\text{ pF}$ , $f_{IN}=20\text{ KHz}$ , RMS value		80	160	$\mu\text{A}$
$V_{DDUV+}$ $V_{BSUV+}$	$V_{DD}$ and $V_{BS}$ Supply Under-Voltage Positive Going Threshold Voltage	$V_{DD}=\text{Sweep}$ , $V_{BS}=\text{Sweep}$	7.8	8.8	9.8	V
$V_{DDUV-}$ $V_{BSUV-}$	$V_{DD}$ and $V_{BS}$ Supply Under-Voltage Negative Going Threshold Voltage	$V_{DD}=\text{Sweep}$ , $V_{BS}=\text{Sweep}$	7.3	8.3	9.3	V
$V_{DDHYS}$ $V_{BSHYS}$	$V_{DD}$ and $V_{BS}$ Supply Under-Voltage Lockout Hysteresis Voltage	$V_{DD}=\text{Sweep}$ , $V_{BS}=\text{Sweep}$		0.5		V
$I_{LK}$	Offset Supply Leakage Current	$V_B=V_S=600\text{ V}$			10	$\mu\text{A}$
$I_{QBS}$	Quiescent $V_{BS}$ Supply Current	$V_{IN}=0\text{ V}$ or $5\text{ V}$ , $C_{LOAD}=1000\text{ pF}$		60	100	$\mu\text{A}$
$I_{PBS}$	Operating $V_{BS}$ Supply Current	$C_{LOAD}=1000\text{ pF}$ , $f_{IN}=20\text{ KHz}$ , RMS Value		420	600	$\mu\text{A}$
<b>Input Logic Section</b>						
$V_{IH}$	Logic "1" Input Voltage		2.5			V
$V_{IL}$	Logic "0" Input Voltage				0.8	V
$I_{IN+}$	Logic Input High Bias Current	$V_{IN}=5\text{ V}$		50	75	$\mu\text{A}$
$I_{IN-}$	Logic Input Low Bias Current	$V_{IN}=0\text{ V}$			2	$\mu\text{A}$
$R_{IN}$	Input Pull-Down Resistance		60	100		$\text{K}\Omega$
<b>Gate Driver Output Section</b>						
$V_{OH}$	High Level Output Voltage ( $V_{BIAS} - V_O$ )	No Load			0.1	V
$V_{OL}$	Low Level Output Voltage	No Load			0.1	V
$I_{O+}$	Output High, Short-Circuit Pulsed Current	$V_{HO}=0\text{ V}$ , $V_{IN}=5\text{ V}$ , $PW \leq 10\text{ }\mu\text{s}$	200	250		mA
$I_{O-}$	Output Low, Short-Circuit Pulsed Current	$V_{HO}=15\text{ V}$ , $V_{IN}=0\text{ V}$ , $PW \leq 10\text{ }\mu\text{s}$	400	500		mA
$V_S$	Allowable Negative $V_S$ Pin Voltage for IN Signal Propagation to HO	$V_{BS}=15\text{ V}$		-9.8	-7.0	V

## Dynamic Electrical Characteristics

$V_{DD}=V_{BS}=15\text{ V}$ ,  $C_{LOAD}=1000\text{ pF}$ , and  $T_A=25^\circ\text{C}$ , unless otherwise specified.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$t_{on}$	Turn-On Propagation Delay Time	$V_S=0\text{ V}$	70	120	170	ns
$t_{off}$	Turn-Off Propagation Delay Time	$V_S=0\text{ V}$	70	120	170	ns
$t_r$	Turn-On Rise Time			70	140	ns
$t_f$	Turn-Off Fall Time			30	60	ns

Typical Characteristics

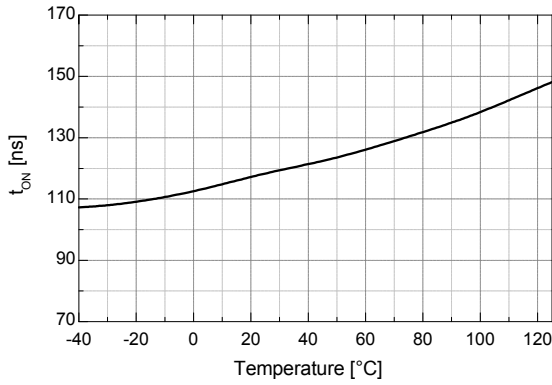


Figure 5. Turn-On Propagation Delay vs. Temperature

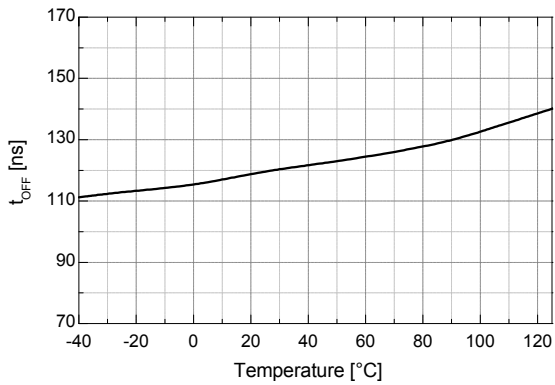


Figure 6. Turn-Off Propagation Delay vs. Temperature

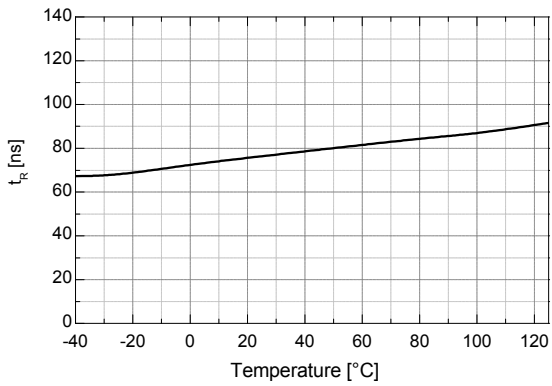


Figure 7. Turn-On Rise Time vs. Temperature

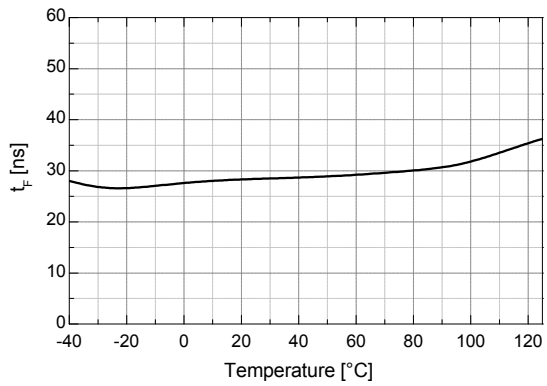


Figure 8. Turn-Off Fall Time vs. Temperature

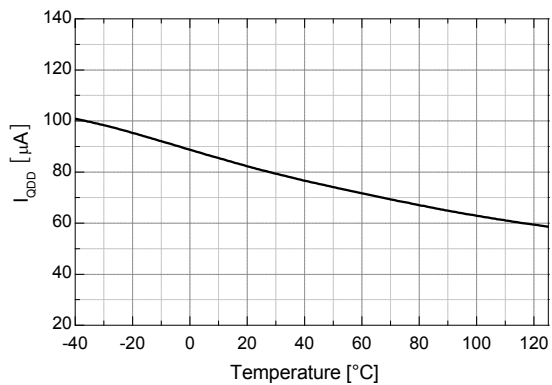


Figure 9. Quiescent V<sub>DD</sub> Supply Current vs. Temperature

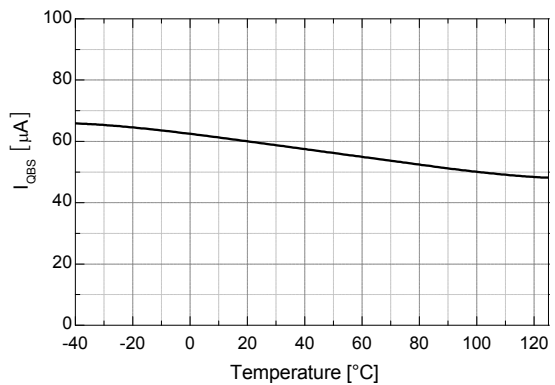


Figure 10. Quiescent V<sub>BS</sub> Supply Current vs. Temperature

Typical Characteristics (Continued)

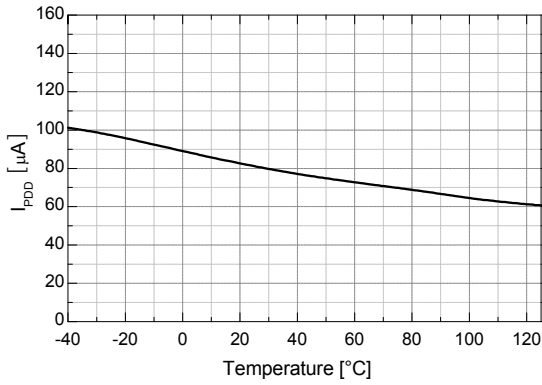


Figure 11. Operating V<sub>DD</sub> Supply Current vs. Temperature

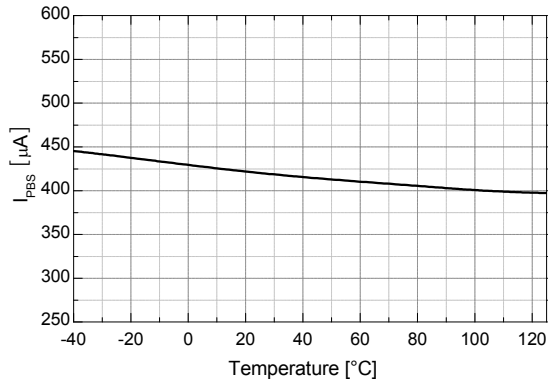


Figure 12. Operating V<sub>BS</sub> Supply Current vs. Temperature

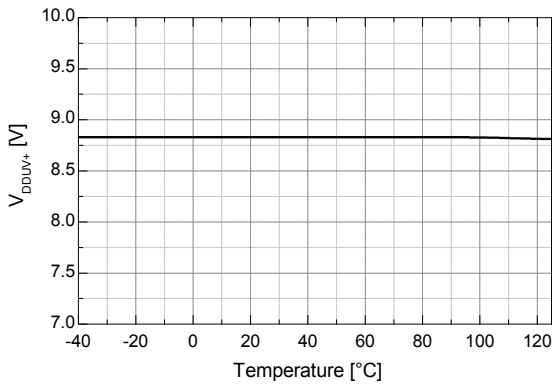


Figure 13. V<sub>DD</sub> UVLO+ vs. Temperature

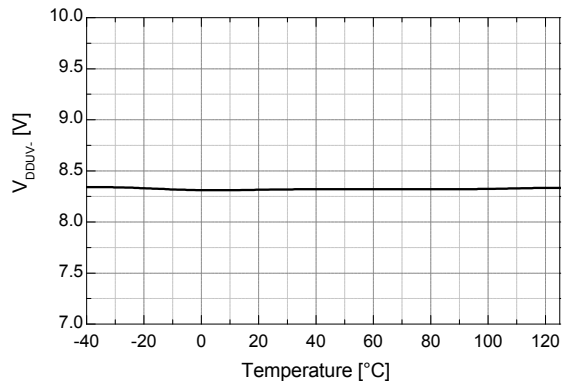


Figure 14. V<sub>DD</sub> UVLO- vs. Temperature

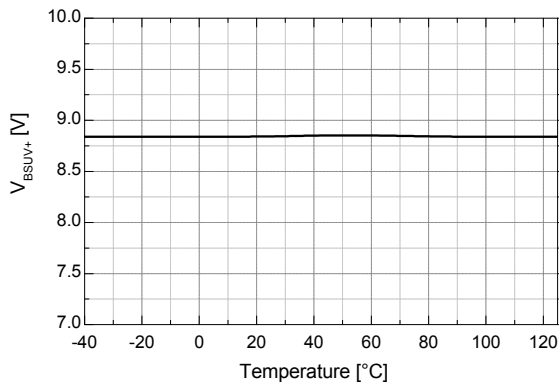


Figure 15. V<sub>BS</sub> UVLO+ vs. Temperature

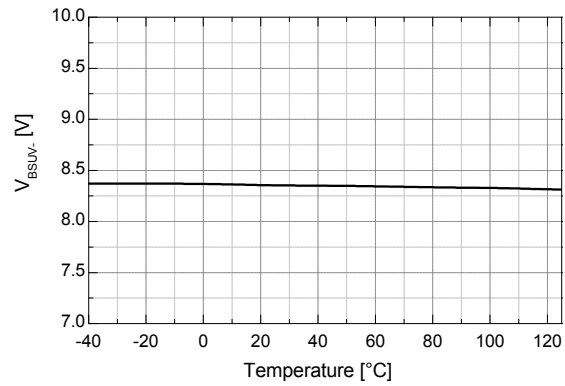


Figure 16. V<sub>BS</sub> UVLO- vs. Temperature



Typical Characteristics (Continued)

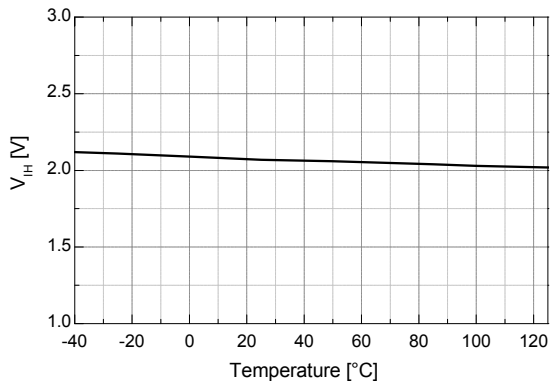


Figure 17. Logic HIGH Input Voltage vs. Temperature

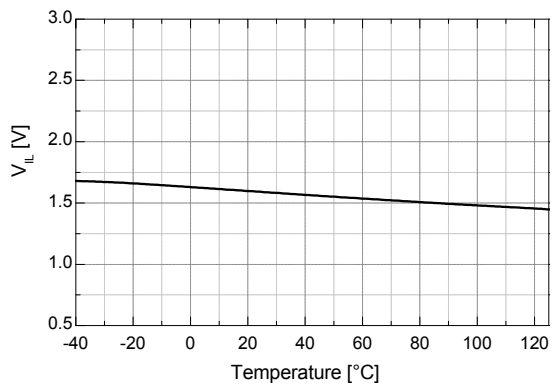


Figure 18. Logic LOW Input Voltage vs. Temperature

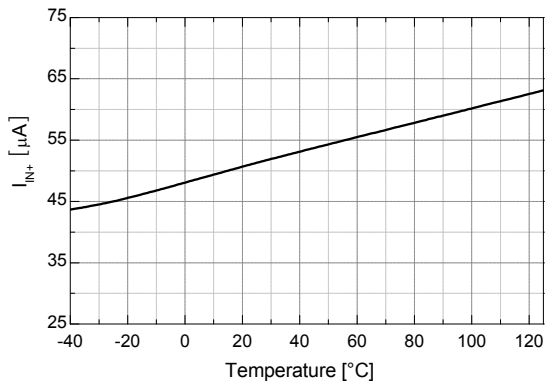


Figure 19. Logic HIGH Input Bias Current vs. Temperature

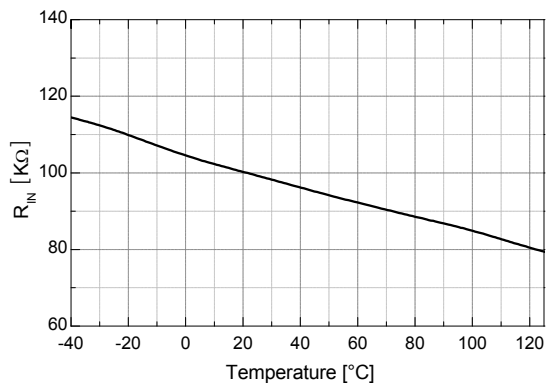


Figure 20. Input Pull-Down Resistance vs. Temperature

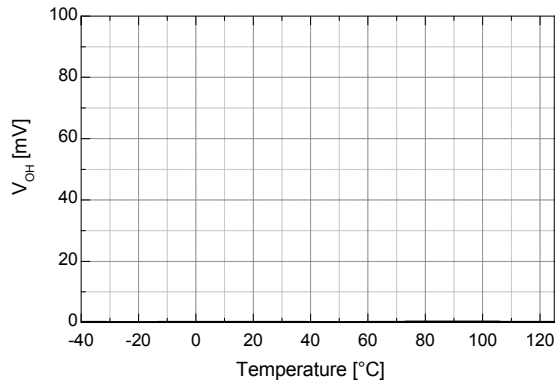


Figure 21. High-Level Output Voltage vs. Temperature

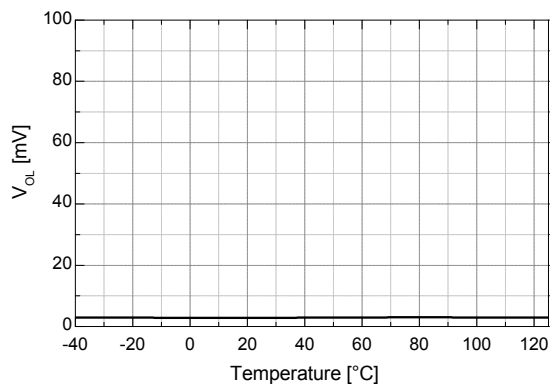


Figure 22. Low-Level Output Voltage vs. Temperature

Typical Characteristics (Continued)

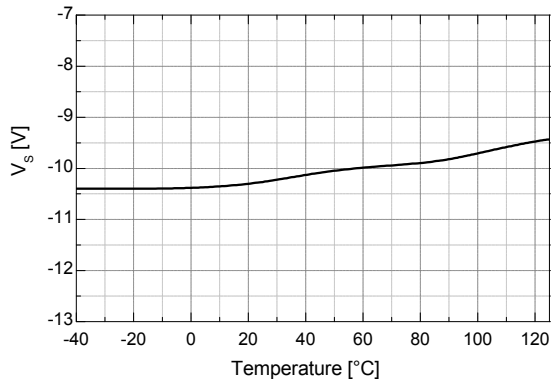


Figure 23. Allowable Negative  $V_S$  Voltage vs. Temperature

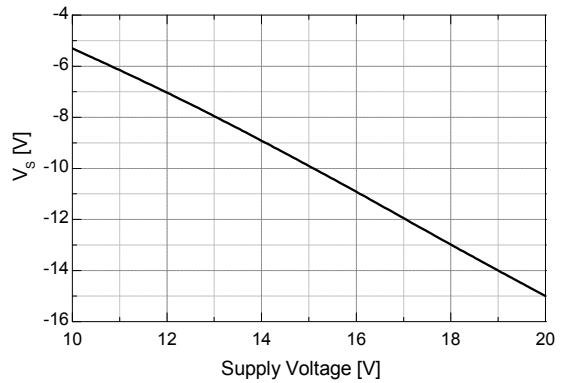


Figure 24. Allowable Negative  $V_S$  Voltage vs. Supply Voltage

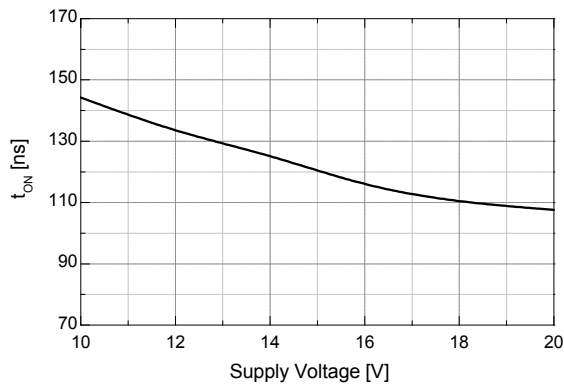


Figure 25. Turn-On Propagation Delay vs. Supply Voltage

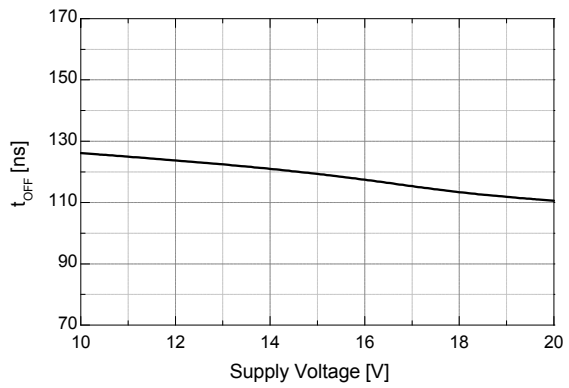


Figure 26. Turn-Off Propagation Delay vs. Supply Voltage

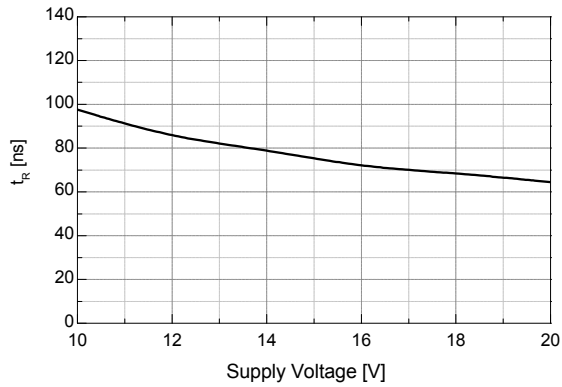


Figure 27. Turn-On Rise Time vs. Supply Voltage

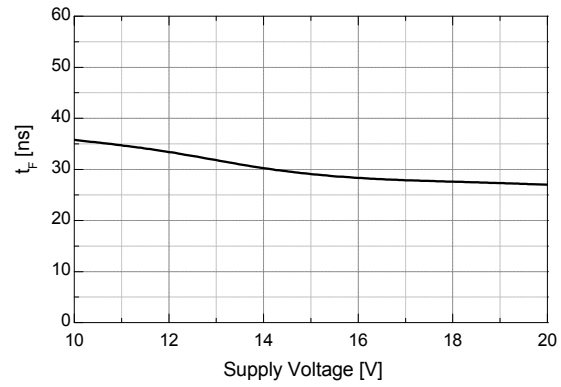


Figure 28. Turn-Off Fall Time vs. Supply Voltage

Typical Characteristics (Continued)

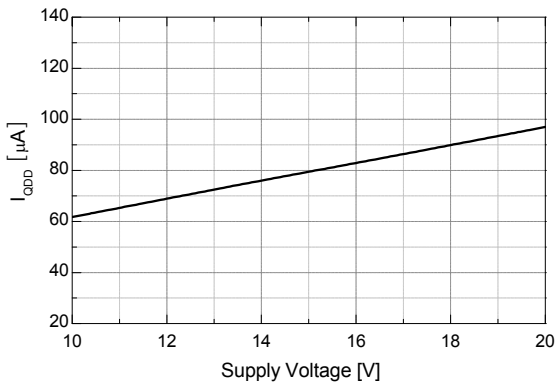


Figure 29. Quiescent  $V_{DD}$  Supply Current vs. Supply Voltage

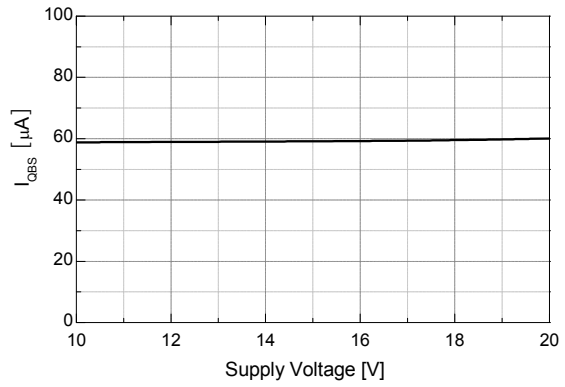


Figure 30. Quiescent  $V_{BS}$  Supply Current vs. Supply Voltage

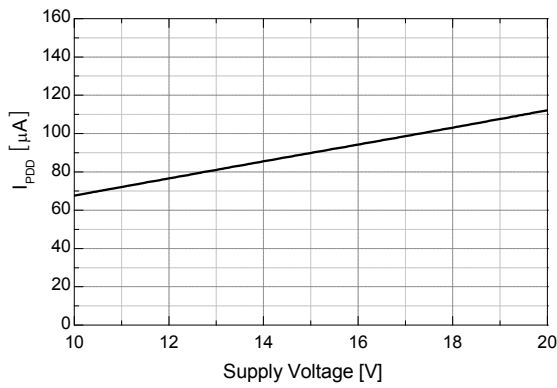


Figure 31. Operating  $V_{DD}$  Supply Current vs. Supply Voltage

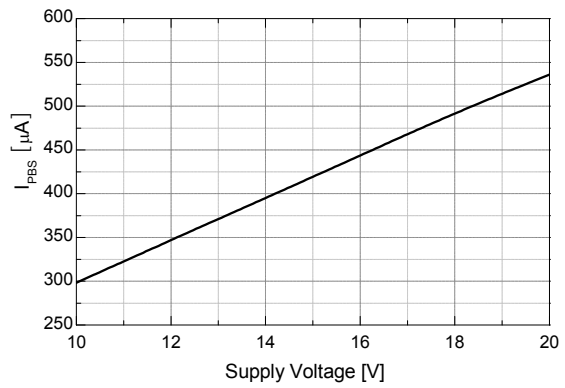


Figure 32. Operating  $V_{BS}$  Supply Current vs. Supply Voltage

### Switching Time Definitions

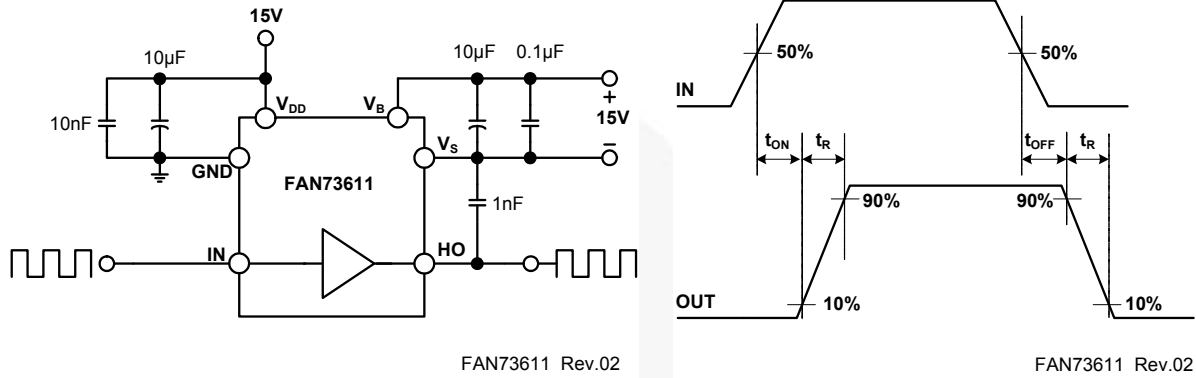


Figure 33. Switching Time Test Circuit and Waveform Definitions

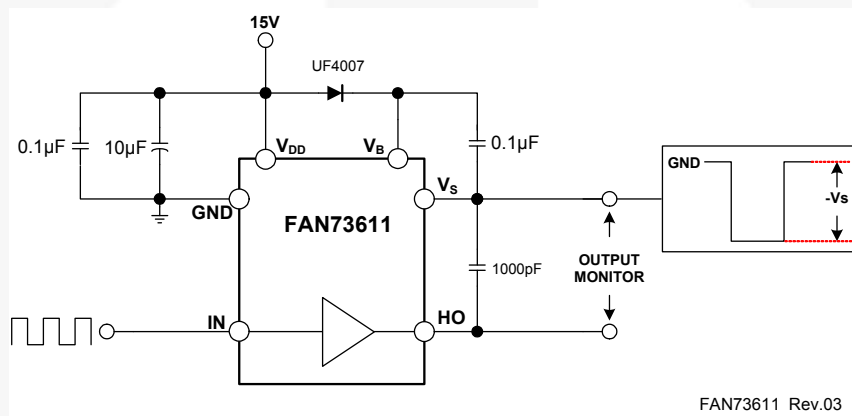


Figure 34. Floating Supply Voltage Transient Test



TOP VIEW



LAND PATTERN RECOMMENDATION



FRONT VIEW



OPTION A  
BEVEL EDGE

OPTION B  
NON-BEVEL EDGE

SIDE VIEW



DETAIL "B"  
SCALE 2:1

NOTES: UNLESS OTHERWISE SPECIFIED

- A. THIS PACKAGE CONFORMS TO JEDEC MS-012 VARIATION A EXCEPT WHERE NOTED.
- B. ALL DIMENSIONS ARE IN MILLIMETERS
- $\triangle C$  OUT OF JEDEC STANDARD VALUE
- D. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR EXTRUSIONS.
- E. LAND PATTERN AS PER IPC SOIC127P600X175-8M
- F. DRAWING FILENAME: MKT-M08Brev2



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- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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